



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Yu, et al.

Attorney Docket No.:
NOVLP078/NVLS2856

Application No.: 10/670,660

Examiner: Unassigned

Filed: September 24, 2003

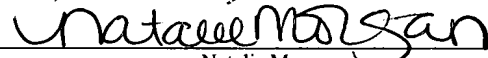
Group: Unassigned

Title: NOVEL FILM FOR COPPER DIFFUSION
BARRIER

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on December 11, 2003 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: _____


Natalie Morgan

**INFORMATION DISCLOSURE STATEMENT
37 CFR §§1.56 AND 1.97(b)**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The references listed in the attached PTO Form 1449, copies of which are attached, may be material to examination of the above-identified patent application. Applicants submit these references in compliance with their duty of disclosure pursuant to 37 CFR §§1.56 and 1.97. The Examiner is requested to make these references of official record in this application.

This Information Disclosure Statement is not to be construed as a representation that a search has been made, that additional information material to the examination of this application does not exist, or that these references indeed constitute prior art.

This Information Disclosure Statement is: (i) filed within three (3) months of the filing date of the above-referenced application, (ii) believed to be filed before the mailing date of a first Office Action on the merits, or (iii) believed to be filed before the mailing of a first Office Action after the filing of a Request for Continued Examination under §1.114. Accordingly, it is believed that no fees are due in connection with the filing of this Information Disclosure Statement. However, if it is determined that any fees are due, the Commissioner is hereby authorized to charge such fees to Deposit Account 500388 (Order No. NOVLP078)

Respectfully submitted,

BEYER WEAVER & THOMAS, LLP


Roger S. Sampson
Registration No. 44,314

P.O. Box 778
Berkeley, CA 94704-0778



Form 1449 (Modified)	Atty Docket No. NOVLP078/NVLS2856	Application No.: 10/670,660
Information Disclosure Statement By Applicant	Applicant: Yu, et al.	
(Use Several Sheets if Necessary)	Filing Date September 24, 2003	Group Unassigned

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
	A						
	B						

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
	C							
	D							
	E							
	F							
	G							

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
	H	Masahiko Maeda, et al., "A Low-Permittivity Interconnection Using an SiBN Interlayer", September 1989, IEEE Transactions on Electron Devices, Vol. 36, No. 9.
	I	Takashi Sugino, et al., "Synthesis of boron nitride film with low dielectric constant for its application to silicon ultralarge scale integrated semiconductors", 2001 Elsevier Science B.V., Diamond and Related Materials 1275-1379.
Examiner		Date Considered

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.